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(12) **United States Design Patent**
Lin

(10) **Patent No.:** **US D513,752 S**
(45) **Date of Patent:** **** Jan. 24, 2006**

(54) **COMPUTER MAINFRAME FRONT PANEL**

D476,992 S * 7/2003 Chien et al. D14/444

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* cited by examiner

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(**) Term: **14 Years**

(57) **CLAIM**

The ornamental design for a computer mainframe front panel, as shown and described.

(21) Appl. No.: **29/210,333**

(22) Filed: **Jul. 30, 2004**

DESCRIPTION

(51) **LOC (8) Cl.** **14-02**

(52) **U.S. Cl.** **D14/444**

(58) **Field of Classification Search** D14/441-446;
D13/162, 184, 199; 312/223.2; 361/680-686,
361/690-696

See application file for complete search history.

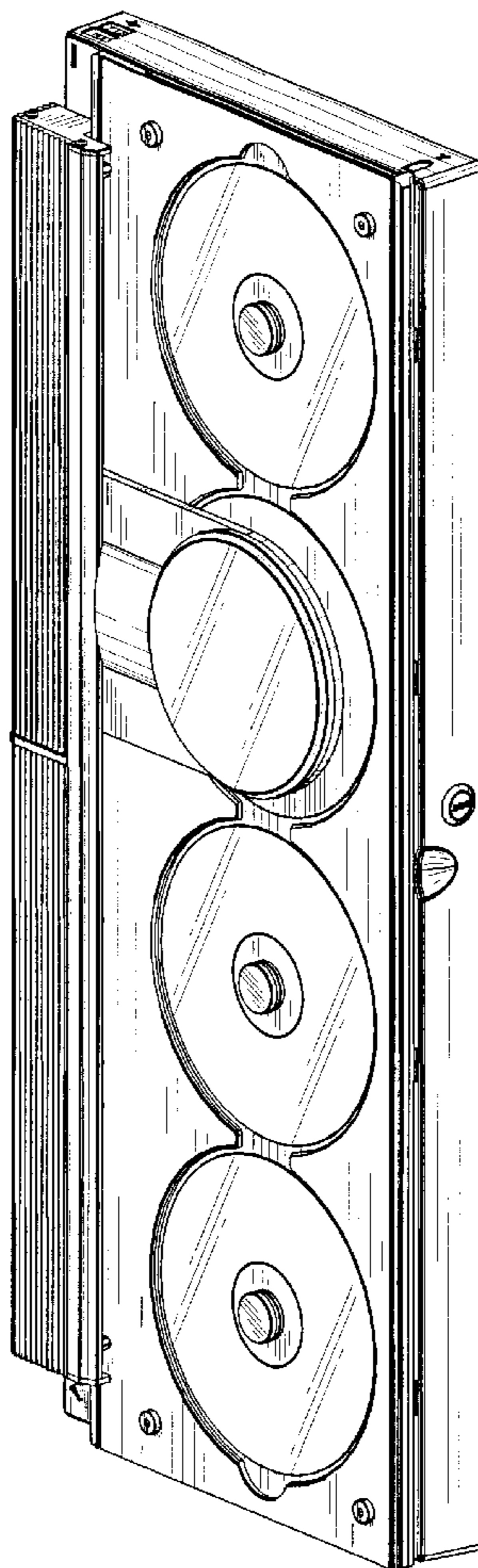
FIG. 1 is a top, front and right side perspective view of a computer mainframe front panel showing my new design; FIG. 2 is a front elevational view thereof; FIG. 3 is a rear elevational view thereof; FIG. 4 is a left side elevational view thereof; FIG. 5 is a right side elevational view thereof. FIG. 6 is a top plan view thereof; FIG. 7 is a bottom plan view thereof; and, FIG. 8 is a top, front and right side perspective view thereof, shown with the fronts in an open position.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D349,108 S * 7/1994 Chang et al. D14/441
D474,186 S * 5/2003 Frank et al. D14/444

1 Claim, 6 Drawing Sheets



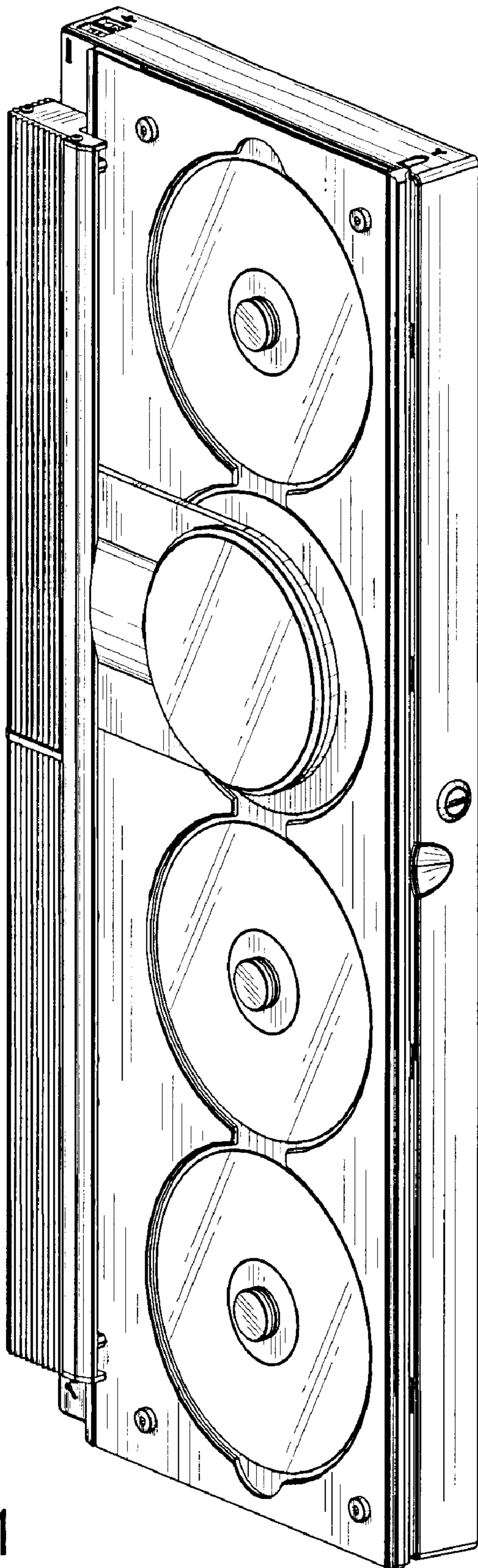


Fig. 1

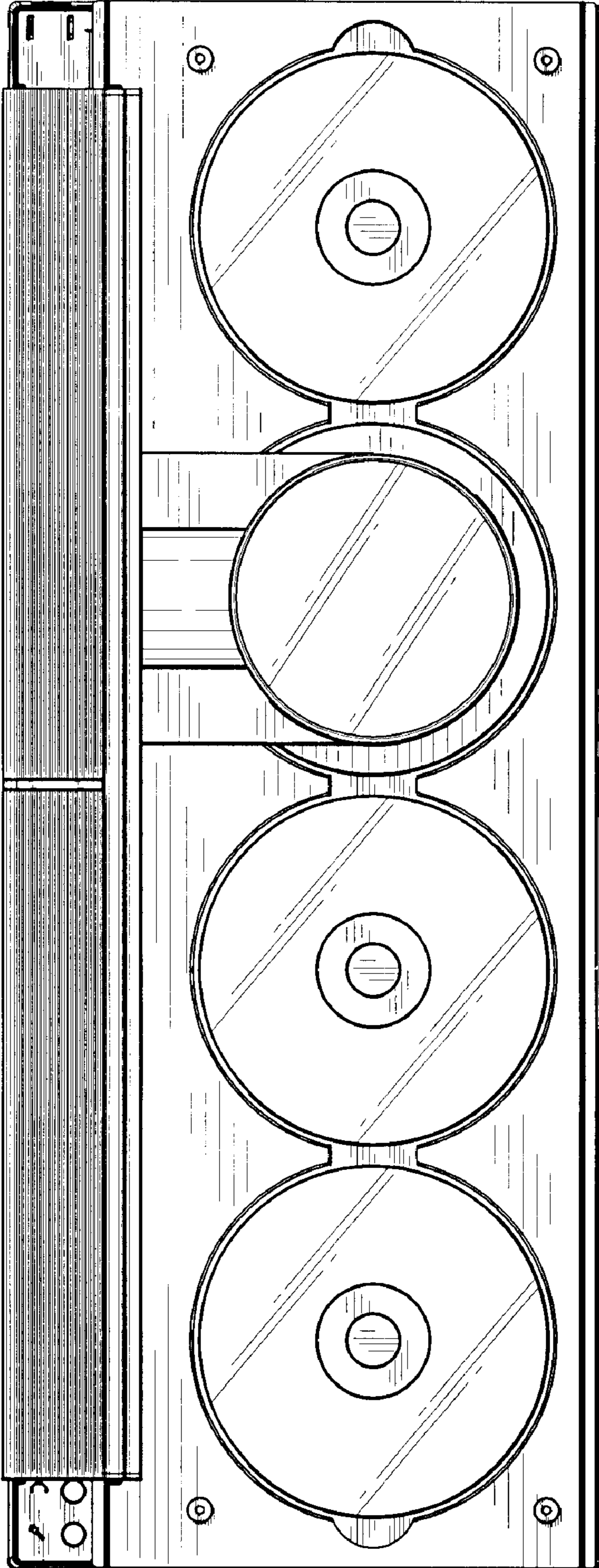


Fig. 2

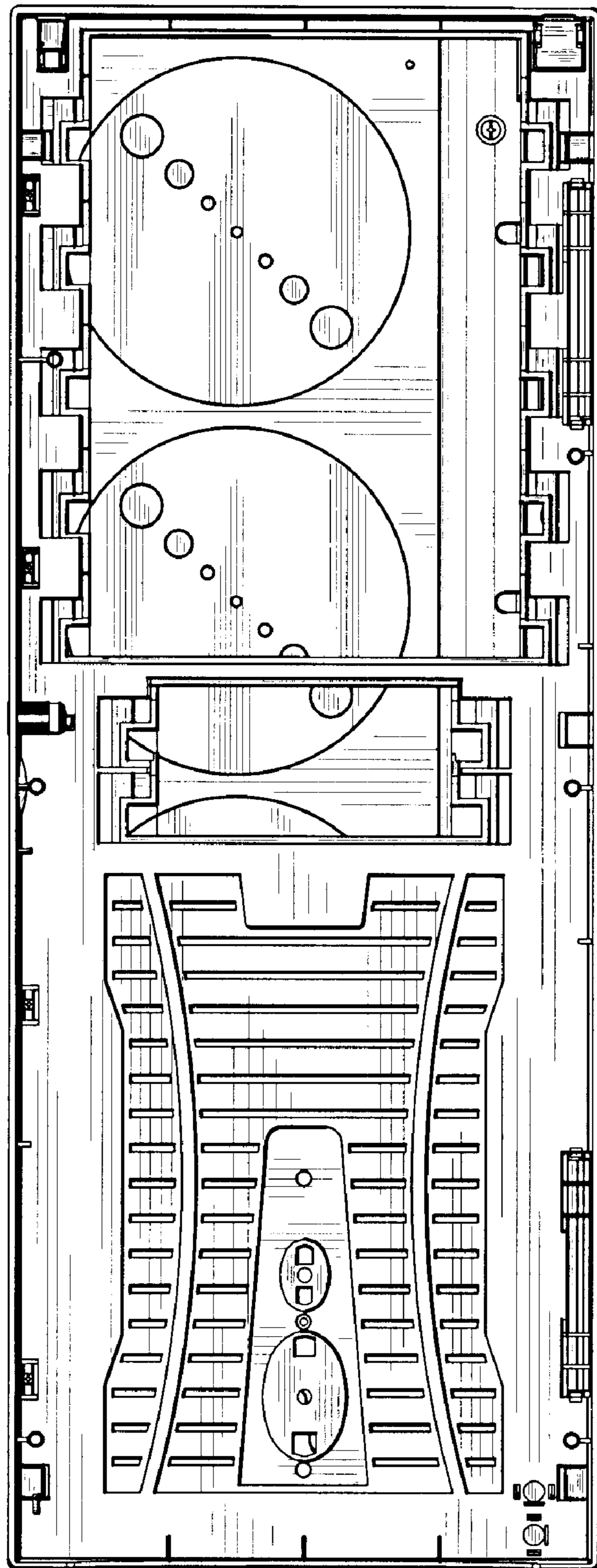


Fig. 3

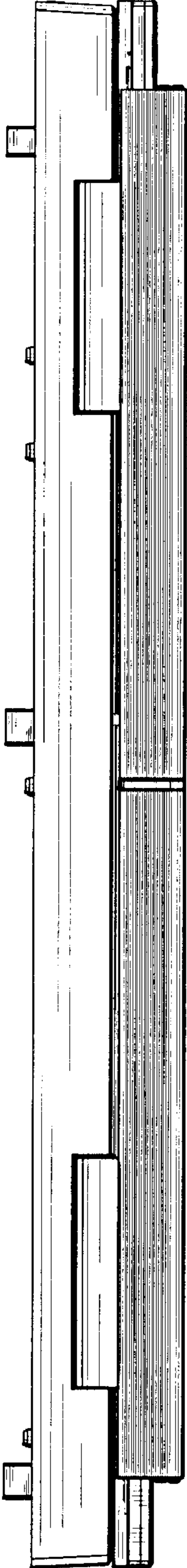


Fig. 4

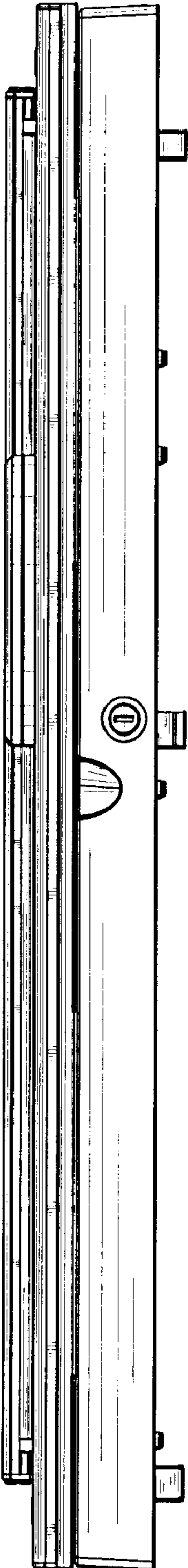


Fig. 5

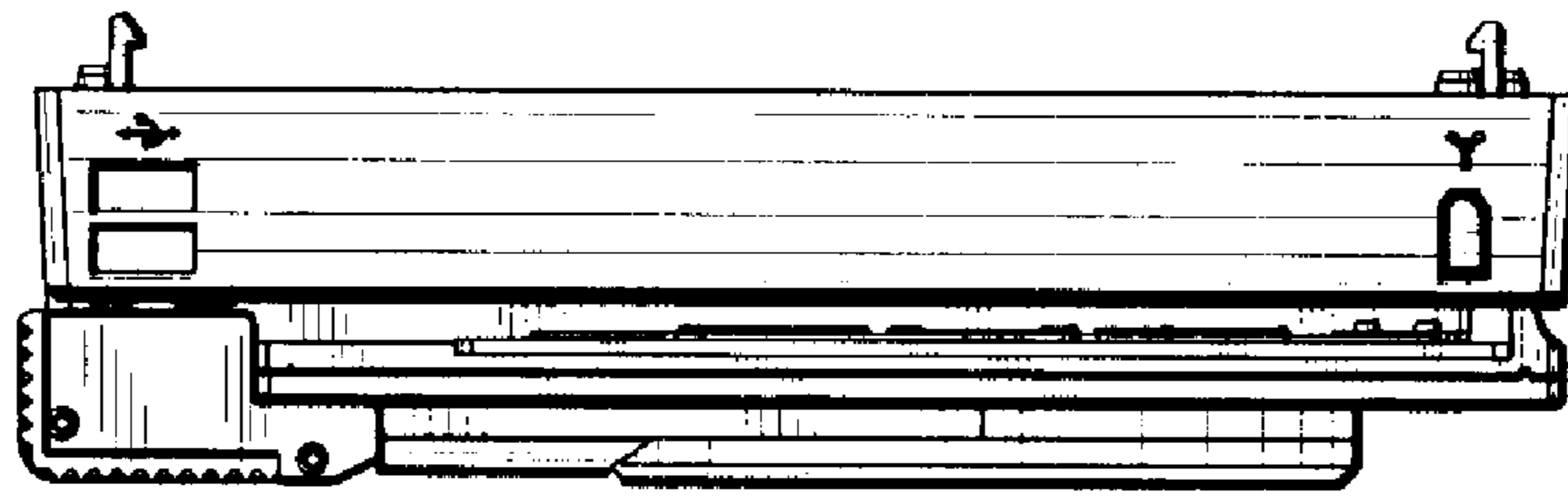


Fig. 6

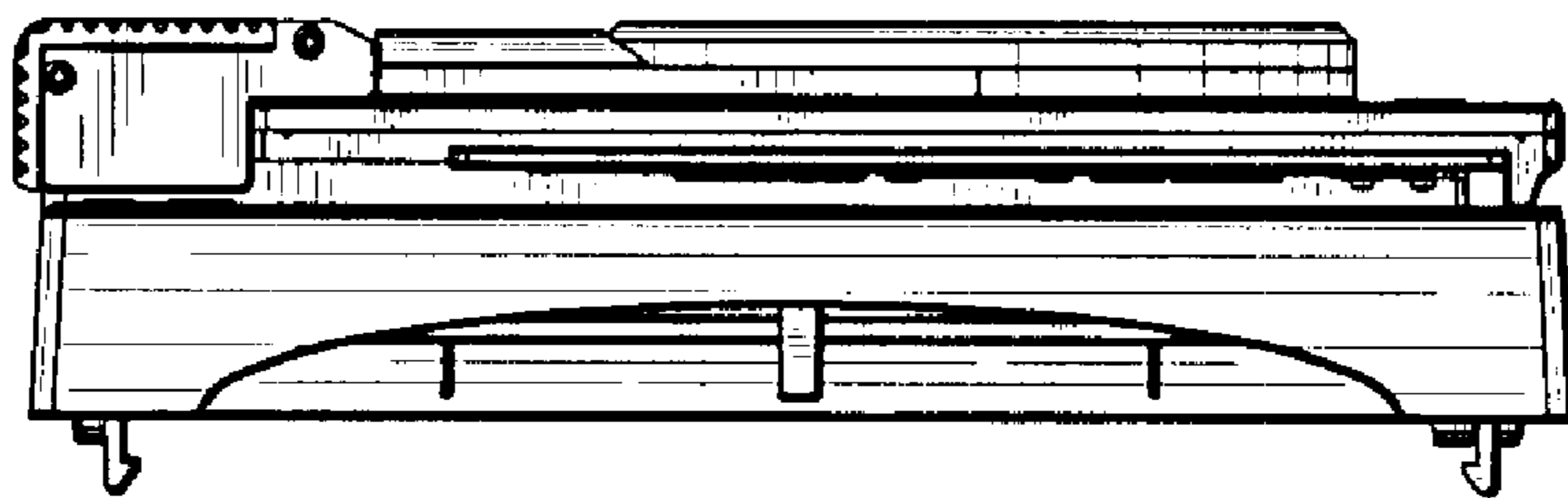


Fig. 7

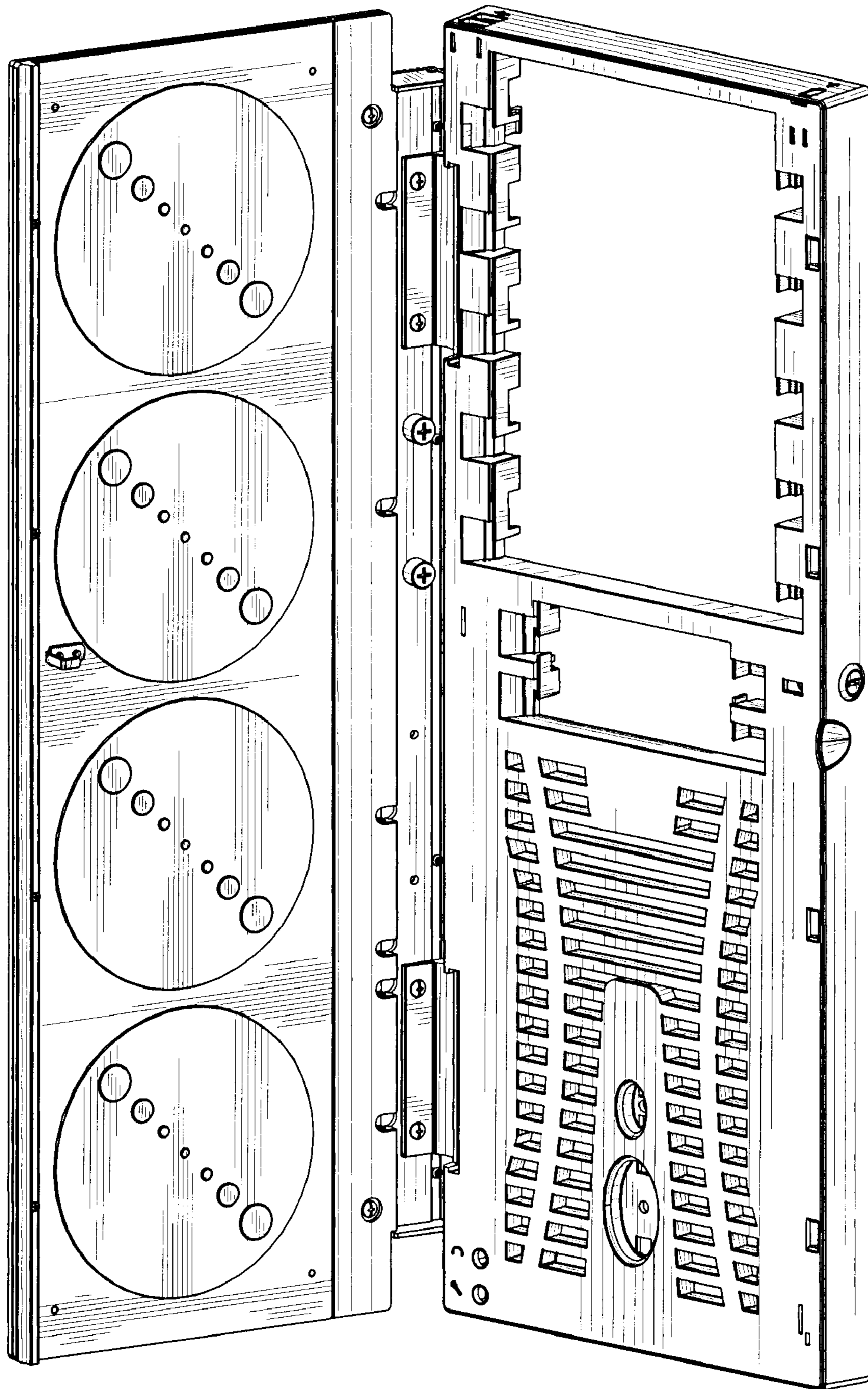


Fig. 8